# MIC-6314

## OpenVPX CPU Blade with 4th/ 5th Generation Intel® Core™ Processor



#### **Features**

- 4th/5th Generation Intel® Core™ processor, up to 4 cores / 8 threads
- Intel® QM87 PCH
- Triple independent display support
- OpenVPX MOD6-PAY-4F1Q2U2T-12.2.1-2 profile compliant
- Onboard and SO-DIMM DDR3L-1600, up to 16 GB, with ECC support
- TwoPCIEx8 ports on the data plane and two PClex8 ports on the extension plane
- Four 1000BASE-T ports on Base interface (two configurable to SERDES)
- Two 1000BASE-T front panel ports
- One SSD and one onboard flash storage device



#### Introduction

The MIC-6314 is Advantech's next generation single processor 6U VPX blade, based on the 4th/5th Generation Intel® Core™ embedded platform with increased cache size and efficiency, as well as instruction set improvements. The MIC-6314 provides two configurable PCIE x 8 ports in the VPX data plane and two PCI Express ports x8 lanes in the VPX expansion plane to enable the highest performance available in the 6U VPX form factor compute intense applications. These PCIE interfaces offer high speed up to PCIE gen. 2 (5Gb/s) throughput, low latency, scalable, error recoverable deterministic interconnectivity to the mainstream peripherals and I/O cards such as DSP and FPGA cards. The PCIE widths and ports on the data plane and the extension plane of MIC-6314 is user configurable, which make MIC-6314 capable to replace the PCIE switch blade in a small system.

With a SO-DIMM socket and additional soldered, onboard DRAM with ECC in a dual channel design running up to 1600MT/s, the MIC-6314 can be integrated into various harsh environments while maintaining maximum memory throughput, and supports memory expansion by using the latest SO-DIMM technology simultaneously.

Tailored for harsh environments, the MIC-6314 has a native ruggedized convection cooled heat sink adaptable to various chassis environments; with the alternated optional air cooled heat sink, additional I/O is provided on the front panel. An onboard soldered, industrial SSD is included for maximum reliability, and a SSD socket is also available for a cost-efficient, modular storage. By using Intel®'s powerful PCH (Lynx Point) with its advanced SATA controller, the MIC-6314 offers high storage capacity at up to 6Gbps transfer speed. An onboard XMC site with PCle x8 gen.3 connectivity can host high speed offload or I/O mezzanines. Two USB 3.0 ports on the front panel can connect to external devices with up to 5Gbps data rate. Network and remote connectivity can be achieved via a RS-232 console (RJ-45) and two GbE RJ-45 ports, powered by Intel®'s latest Gigabit Ethernet controller.

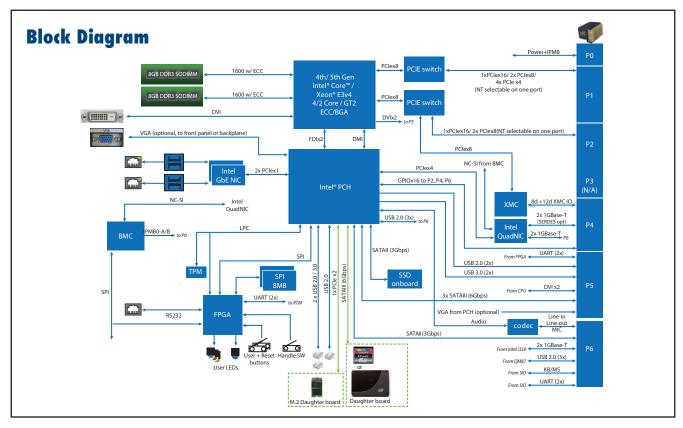
The Intel® next generation graphics engine Iris Pro offers up to 2x the graphic performance compared to previous generation solutions. Triple independent display support can be implemented by using VGA and 2 DVI ports on MIC6314. Audio is powered by a ALC892 controller via the backplane interface, and provides media support. A PCIEinterface is reserved for the optional M.2 high speed storage. Besides the modern M.2 storage, three SATA III one SATA II and four USB ports (2x USB 3.0, 2x USB 3.0) are also connected to the backplane to fulfill the demand for extra IO ports or storage. Four GbE ports (two SERDES selectable) support system level IP connectivity, and four UART interfaces (RS232/422/485 selectable) can be leveraged to interface to legacy devices and consoles.

### **Specifications**

CPU	Intel® Core™ I7-5850EQ/i5-4402E*	
Max. Speed	3.4 GHz	
Chipset	Intel® QM87	
BIOS	Redundant AMI UEFI based 8MByte SPI flash	
Technology	Dual channel DDR3L 1600MHz w/ ECC	
Max. Capacity	Configurable up to 16GB	
Socket	8GB memory soldered onboard, 1x 204-pin SODIMM socket max. to 8GB	
P1	2x PCIEx8 Gen2 configurable to 1 x 16 or 4 x 4	
P2	2x PClex8 (1 port NT Capable)	
P4	8d+12d XMC IO;, 2x 10/100/1000BT (alternative of SerDes) from I350	
P5	2x USB3.0; 2x USB 2.0; 3x SATA-III; DVI x2; 2x UART(RS-232/422/485 switchable)	
P6	2x 10/100/1000BT; Audio from ALC892; 2x USB 2.0; KB/Mouse from SIO;1x SATA II	
Controller	Intel® Iris™ Pro Graphics 6200 (3 independent displays)	
Controller	Intel® 1350-AM4 Quad Port Gigabit Ethernet Controller to backplane; 2x I210 to front panel	
Serial (COM)	1 RS-232 on RJ-45 connector,	
Ethernet	2 x RJ-45 10/100/1000BASE-T	
USB	2x USB 3.0, 1x USB2.0	
Miscellaneous	XMC, DVI	
Compatibility	Linux; Windows7	
Onboard Flash	64G SATA	
Consumption 59 W total power envelope with 47W CPU		
PCB Dimensions	4HP, 233.35 x 160 mm (9.2" x 6.3") (W x D)	
Weight	0.95kg without peripherals	
	Max. Speed Chipset BIOS Technology Max. Capacity Socket P1 P2 P4 P5 P6 Controller Controller Serial (COM) Ethernet USB Miscellaneous Compatibility Onboard Flash Consumption PCB Dimensions	

## **Specifications (Cont.)**

		Operating (with 30 CFM airflow)	Non-operating
	Temperature	-40 ~ 70° C	-50 ~ 100° C
	Humidity	95% @ 40° C, non-condensing	95% @ 60° C, non-condensing
Environment	Shock	VITA 47, OS2 VITA 47, OS1 (ruggedized convection cooled)	
	Vibration	VITA 47, V2 (ruggedized convection cooled) 0.008 g <sup>2</sup> /Hz, 2 Grms, 5-500Hz (convection cooled)	
	Altitude	50,000ft @ -40° C above sea level	
	VPX	OpenVPX (VITA 65), REDI (VITA 48), IPMI 2.0	
Compliance	Safety	FCC class A, CE, RoHS	
	EMC	FCC47 CFR Part15, Class A, CE Mark (EN55022/EN5502	24/EN300386)



	Front Panel			Main On-board Features						
Part Number	Display	USB	Ethernet (RJ45)	Console (RJ45)	CPU	Onboard Memory	Onboard Flash	External storage	SODIMM Socket	XMC site
MIC-6314-A1A4E	DVI x1	2.0x1; 3.0x2	2	1	17-5850EQ	8GB	64GB	SSD site	Yes	No
MIC-6314-A2A4E (POR)*	DVI x1	2.0x1; 3.0x2	2	1	17-5850EQ	8GB	64GB	M.2 site	Yes	Yes
MIC-6314-B1C4F	VGA x1	3 0x2	0	0	i5-4402F	8GB	64GB	SSD site	No	No

## **Ordering Information\*\***

Model number	Configuration
MIC-6314-A1A4E	MIC-6314 with I7-5850EQ, convection heat sink, SSD site
MIC-6314-A2A4E	MIC-6314 with I7-5850EQ, convection heat sink, XMC & M.2 site
MIC-6314-B1C4E	MIC-6314 with i5-4402E, ruggedized convection cooled heat sink. SSD site

 $<sup>^\</sup>star$ : For the other Intel® 4th/5th generation Core family CPU availability, please contact your local sales office.

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